



**CHENMKO ENTERPRISE CO.,LTD**

**SURFACE MOUNT**

**N-Channel Enhancement Mode Field Effect Transistor**

VOLTAGE 60 Volts CURRENT 30 Ampere

**CHM6060RPAPT**

Lead free devices

**APPLICATION**

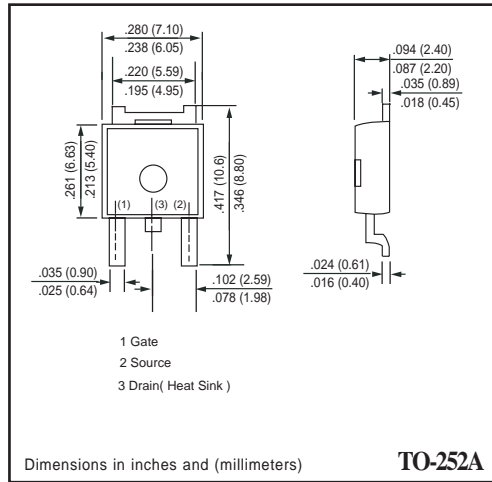
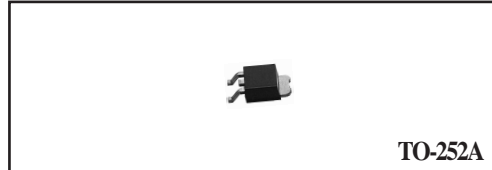
- \* Servo motor control.
- \* Power MOSFET gate drivers.
- \* Other switching applications.

**FEATURE**

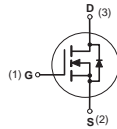
- \* Small package. (TO-252A)
- \* Super high dense cell design for extremely low R<sub>DS(ON)</sub>.
- \* High power and current handling capability.

**CONSTRUCTION**

- \* N-Channel Enhancement



**CIRCUIT**



**Absolute Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	CHM6060RPAPT	Units
V <sub>DSS</sub>	Drain-Source Voltage	60	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Maximum Drain Current - Continuous	30	A
	- Pulsed (Note 3)	120	
P <sub>D</sub>	Maximum Power Dissipation at T <sub>c</sub> = 25°C	50	W
T <sub>J</sub>	Operating Temperature Range	-55 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C

- Note : 1. Surface Mounted on FR4 Board , t <= 10sec  
 2. Pulse Test , Pulse width <= 300us , Duty Cycle <= 2%  
 3. Repetitive Rating , Pulse width limited by maximum junction temperature  
 4. Guaranteed by design , not subject to production trsting

**Thermal characteristics**

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1)	50	°C/W
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## RATING CHARACTERISTIC CURVES ( CHM6060RPAPT )

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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### OFF CHARACTERISTICS

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	60			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$			25	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
$I_{GSSR}$	Gate-Body Leakage	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

### ON CHARACTERISTICS (Note 2)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2		4	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=24\text{A}$			25	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS}=10\text{V}, I_D=24\text{A}$		20		S

### SWITCHING CHARACTERISTICS (Note 4)

$Q_g$	Total Gate Charge	$V_{DS}=48\text{V}, I_D=30\text{A}$ $V_{GS}=10\text{V}$		36	43	nC
$Q_{gs}$	Gate-Source Charge			9		
$Q_{gd}$	Gate-Drain Charge			19		
$t_{on}$	Turn-On Time	$V_{DD}=30\text{V}$ $I_D=30\text{A}, V_{GS}=10\text{V}$ $R_{GEN}=7.5\ \Omega$		15	20	nS
$t_r$	Rise Time			250	300	
$t_{off}$	Turn-Off Time			45	60	
$t_f$	Fall Time			130	150	

### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

$I_S$	Drain-Source Diode Forward Current			30	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$I_S = 24\text{A}, V_{GS} = 0\text{V}$		0.9	1.3	V